

NCE30TD60BF

600V, 30A, Trench FS II Fast IGBT

General Description

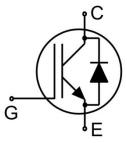
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FS II IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology offering
- Very low V_{CE(sat)}
- High speed switching
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE30TD60BF	TO-220F	NCE30TD60BF



Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol Parameter Value **Units** 600 Vces Collector-Emitter Voltage ٧ V_{GES} Gate- Emitter Voltage ±30 V Collector Current 60 Α I_{C} Α Collector Current @T_C = 100°C 30 Pulsed Collector Current, tp limited by Timax 120 Α I_{Cpuls} turn off safe operating area, V_{CE}=600V, T_j=175°C 120 Α Diode Continuous Forward Current @T_C = 100°C I_{F} 30 Α **Diode Maximum Forward Current** 120 I_{FM} Α Power Dissipation @ T_C = 25°C 42 W P_D Power Dissipation @T_C = 100 °C 21 °C Operating Junction and Storage Temperature Range -55 to +175 T_J, T_{sta} °C T_L Maximum Temperature for Soldering 260 Short circuit withstand time V_{GE}=15V, V_{CC}≤400V, Allowed number of short circuits<1000Time between 5 us t_{sc} short circuits: \geq 1.0s, $T_j \leq$ 150°C



NCE30TD60BF

Thermal Characteristic

Symbol	Parameter	Value	Units
R _{0JC}	Thermal Resistance, Junction to case for IGBT	3.57	°C/W
R _{θJC}	Thermal Resistance, Junction to case for Diode	5.26	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	78	°C/W

Electrical Characteristics (T_C=25°C unless otherwise noted)

0	Donomoton.	Conditions		Value			•••
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Charac	cteristics						
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	600			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V	V _{CE} =600V			40	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30	V,V _{CE} =0V			200	nA
I _{GES(R)}	Gate to Emitter Reverse Leakage	V _{GE} =-30V,V _{CE} =0V				200	nA
V	Calleston Fruitton Catavation Voltage	Ic=30A	T _j =25°C		1.7	1.9	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	V _{GE} =15V	T _j =175°C		1.9		V
V _{GE(th)}	Gate Threshold Voltage	I _C =1mA	,V _{CE} =V _{GE}	4.0	5.0	6.0	V
Dynamic Cha	aracteristics						
Cies	Input Capacitance	V _{CE} =25V,V _{GE} =0V, f=1MHz			3552		pF
Coes	Output Capacitance				106		
C _{res}	Reverse Transfer Capacitance				67		
Qg	Total Gate Charge	V _{CC} =480V, I _C =30A V _{GE} =15V			132		nC
Q _{ge}	Gate to Emitter Charge				28		
Q _{gc}	Gate to Collector Charge				54		
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V _{GE} =15V,V _{CC} ≤400V, t _{SC} ≤5us,T _j ≤150°C			180		Α
Switching Ch	naracteristics						
t _{d(ON)}	Turn-on Delay Time				19		
t _r	Rise Time				17		nc
$t_{\text{d(OFF)}}$	Turn-Off Delay Time	Vcc=400V,Ic=30A			166		ns
t _f	Fall Time	V_{GE} =0/15V, R_g =5 Ω			16		
Eon	Turn-On Switching Loss	Inductive Load			0.36		
E _{off}	Turn-Off Switching Loss				0.32		mJ
E _{ts}	Total Switching Loss	1			0.68		7

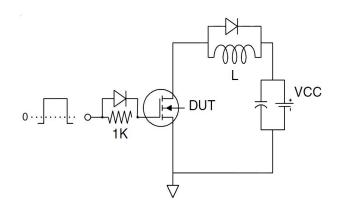
Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified)

Cumbal	Dovementor	Conditions	Rating			l leite	
Symbol	Parameter		Min.	Тур.	Max.	Units	
V _{FM}	Diode Forward Voltage	I⊧=30A		1.75	2.40	V	
Trr	Reverse Recovery Time	1 -204		178		ns	
I _{RRM}	Diode Peak Reverse Recovery Current	l₅=30A, di/dt=200A/us		4		Α	
Qrr	Reverse Recovery Charge	di/di-200A/us		0.4		uC	
Pulse width t _t	Pulse width t _{tp} ≤380μs,δ≤2%						

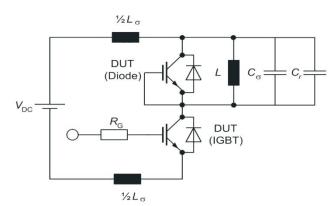


Test Circuit

1) Gate Charge Test Circuit

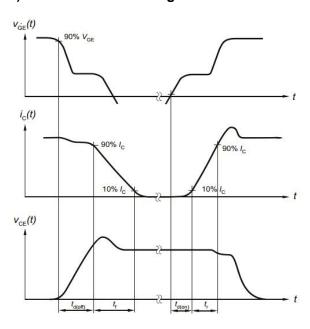


2) Switch Time Test Circuit

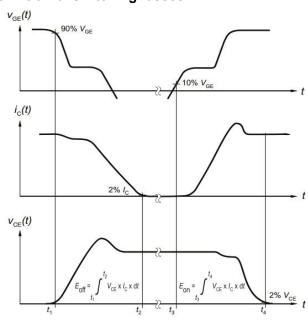


Switching characteristics

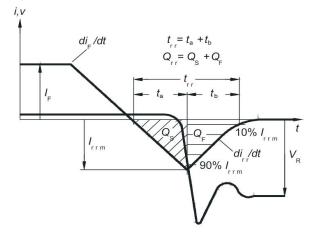
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics



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Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

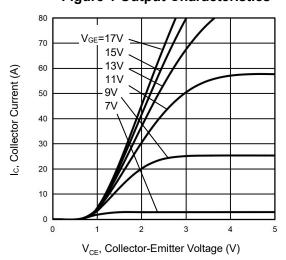


Figure 3 V_{CEsat} vs. Case Temperature

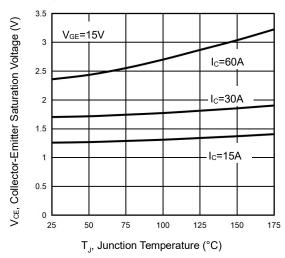


Figure 5 Capacitance Characteristics

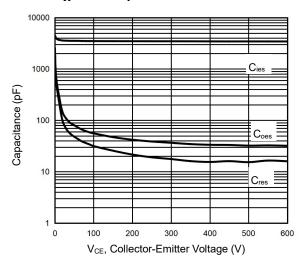


Figure 2 Transfer Characteristics

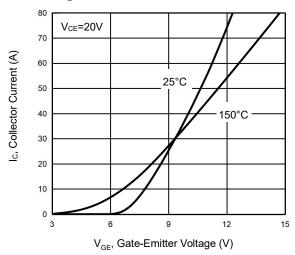


Figure 4 Saturation Voltage vs. V_{GE}

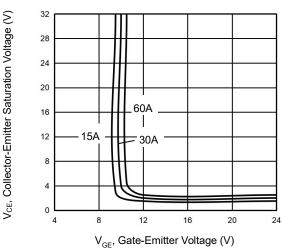
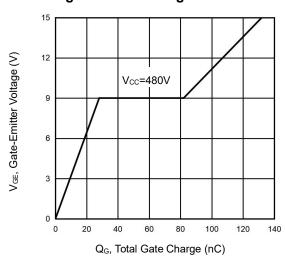


Figure 6 Gate charge waveform



V2.0

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Typical Electrical and Thermal Characteristics

Figure 7 Gate-emitter Threshold Voltage as a Function of Junction Temperature

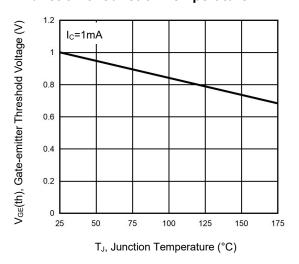


Figure 9 Typical Switching Times as a Function of Gate Resistor

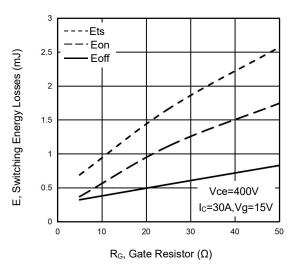


Figure 11 Typical Collector-emitter Saturation
Voltage as a function of Collector Current

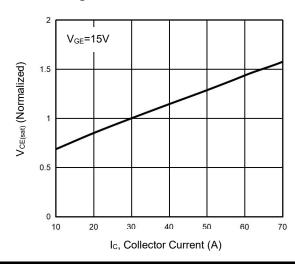


Figure 8 Power Dissipation as a Function of Case Temperature

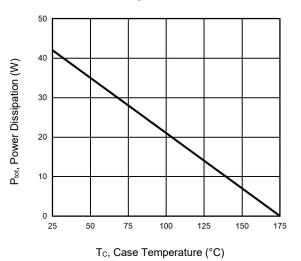


Figure 10 Typical Switching Times as a Function of Junction Temperature

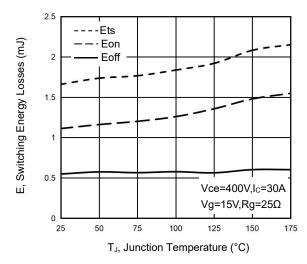
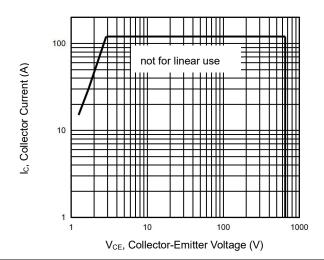


Figure 12 Forward Bias Safe Operating Area



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Typical Electrical and Thermal Characteristics

Figure 13 IGBT Transient Thermal Impedance

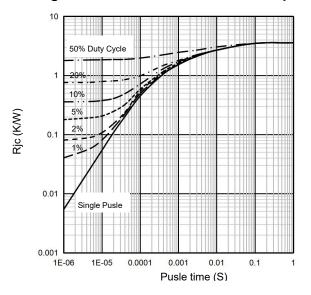
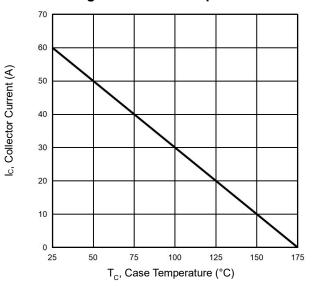


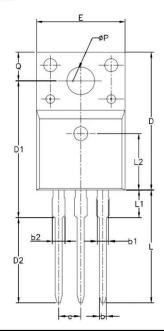
Figure 14 I_C vs. Temperature

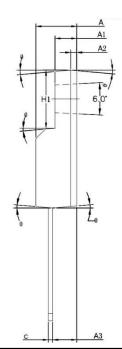


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TO-220F Package Information





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
А	4.50	4.83	0.18	0.19
A1	2.34	2.74	0.09	0.11
A2	0.70 REF		0.03	REF
A3	2.56	2.93	0.10	0.12
b	0.70	0.90	0.03	0.04
b1	1.18	1.38	0.05	0.05
b2		1.47		0.06
С	0.45	0.60	0.02	0.02
D	15.67	16.07	0.62	0.63
D1	15.55	15.95	0.61	0.63
D2	9.60	10.00	0.38	0.39
E	9.96	10.36	0.39	0.41
Q	2.54BSC		0.10BSC	
H1	6.48	6.88	0.26	0.27
L	12.68	13.28	0.50	0.52
L1		3.50		0.14
L2	6.50 REF		0.26	REF
ФР	3.08	3.28	0.12	0.13
Q	3.20	3.40	0.13	0.13
θ1	1°	5°	0.04°	0.20°



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